

Advance Technical Information

Polar3[™] HiPerFET[™] Power MOSFET

IXFN110N60P3

N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Rectifier

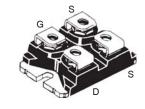


Symbol	Test Conditions	Maximum Ratings		
V _{DSS}	T _J = 25°C to 150°C	600	V	
V _{DGR}	$T_J = 25$ °C to 150°C, $R_{GS} = 1M\Omega$	600	V	
V _{GSS}	Continuous	±30	V	
$V_{\rm GSM}$	Transient	±40	V	
I _{D25}	T _C = 25°C	90	A	
I _{DM}	$T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm JM}$	275	Α	
I _A E _{AS}	T _C = 25°C	55	A	
E _{as}	$T_{C}^{\circ} = 25^{\circ}C$	3	J	
dv/dt	$I_{_{S}} \le I_{_{DM}}, V_{_{DD}} \le V_{_{DSS}}, T_{_{J}} \le 150^{\circ}C$	35	V/ns	
P_{D}	T _c = 25°C	1500	W	
T _J		-55 +150	°C	
T _{JM}		150	°C	
T _{stg}		-55 +150	°C	
V _{ISOL}	50/60 Hz, RMS, t = 1minute	2500	V~	
	$I_{ISOL} \le 1 \text{mA}, \qquad t = 1 \text{s}$	3000	V~	
M _d	Mounting Torque for Base Plate	1.5/13	Nm/lb.in.	
-	Terminal Connection Torque	1.3/11.5	Nm/lb.in.	
Weight		30	g	
Weight	Terminal Connection Forque		1411	

		cteristic Values Typ. Max.			
BV _{DSS}	$V_{GS} = 0V, I_D = 3mA$	600			V
V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 8mA$	3.0		5.0	V
I _{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0V$			±200	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$ $T_{J} = 125^{\circ}C$			50 6	μA mA
R _{DS(on)}	$V_{GS} = 10V, I_{D} = 55A, \text{ Note 1}$			56	mΩ

 $V_{_{DSS}} = 600V$ $I_{_{D25}} = 90A$ $R_{_{DS(on)}} \le 56m\Omega$ $t_{_{rr}} \le 250ns$





G = Gate S = Source D = Drain

Either Source Terminal S can be used as the Source Terminal or the Kelvin Source (Gate Return) Terminal.

Features

- International Standard Package
- miniBLOC with Aluminum Nitride Isolation
- Avalanche Rated
- Low Package Inductance
- Fast Intrinsic Rectifier
- \bullet Low $\mathbf{R}_{\mathrm{DS(on)}}$ and \mathbf{Q}_{G}

Advantages

- Easy to Mount
- Space Savings

Applications

- DC-DC Converters
- Battery Chargers
- Switch-Mode and Resonant-Mode Power Supplies
- Uninterrupted Power Supplies
- AC Motor Drives
- High Speed Power Switching Applications



•				cteristic Values	
$(1_{J} = 25)$	-0 0	nless Otherwise Specified)	Min.	Тур.	Max.
g _{fs}		$V_{DS} = 20V, I_{D} = 55A, \text{ Note 1}$	65	105	S
\mathbf{C}_{iss})			18	nF
\mathbf{C}_{oss}	}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		1650	pF
\mathbf{C}_{rss}	J			5.5	pF
R _{Gi}		Gate Input Resistance		1.0	Ω
t _{d(on)}	$\left. \begin{array}{c} \\ \end{array} \right\}$	Resistive Switching Times		63	ns
t _r		$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 55A$		19	ns
$\mathbf{t}_{d(off)}$				77	ns
t _f		$R_{G} = 1\Omega$ (External)		11	ns
Q _{g(on)})			245	nC
\mathbf{Q}_{gs}	}	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 55A$		83	nC
\mathbf{Q}_{gd}	J			53	nC
R _{thJC}					0.083 °C/W
R _{thCS}				0.05	°C/W

SOT-227B (IXFN) Outline (M4 screws (4x) supplied) SYM INCHES MILLIMETERS MIN MAX MIN MAX A 1,240 1,255 31,50 31,88 B .307 .323 7.80 82.0 C .161 .169 4.09 4.29 D .161 .169 4.09 4.29 E .161 .169 4.09 4.29 F .587 .595 14,91 15,11 G .1186 .1193 30,12 30,30 H .1496 .1,505 38,00 38,23 J .460 .481 11,68 12,22 K .351 .378 8.92 9,60 L .030 .033 0,76 0,84 M .496 .506 12,60 12,85 N .990 1,001 25,15 25,42 O .078 .084 1,98 2,13 P .195 .235 4,95 5,97 O .1045 1,059 26,54 26,90 R .155 .174 3,94 4,42 S .186 .191 4,72 4,85 T .988 .987 24,59 25,07

.004

Source-Drain Diode

Symbol	Test Conditions	onditions Characteristic Values			
(T _J = 25°C Unless Otherwise Specified)		Min.	Min. Typ. Ma		
I _s	$V_{GS} = 0V$			110	Α
I _{SM}	Repetitive, Pulse Width Limited by $\mathrm{T}_{_{\mathrm{JM}}}$			440	Α
V _{SD}	$I_F = 100A, V_{GS} = 0V, Note 1$			1.5	V
$\left\{egin{array}{c} \mathbf{t}_{rr} \\ \mathbf{Q}_{RM} \\ \mathbf{I}_{RM} \end{array}\right\}$	$I_F = 55A$, $-di/dt = 100A/\mu s$ $V_R = 100V$, $V_{GS} = 0V$		1.6 14.0	250	ns μC Α

Note 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

ADVANCE TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.



Fig. 1. Output Characteristics @ $T_J = 25^{\circ}C$

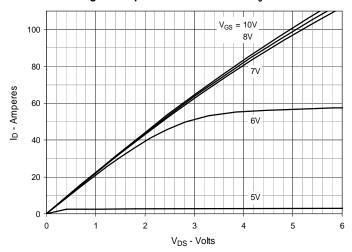


Fig. 2. Extended Output Characteristics @ T_J = 25°C

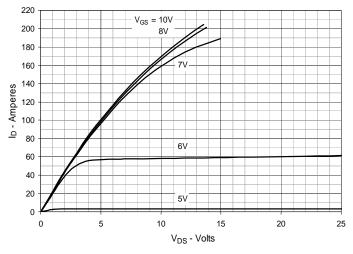


Fig. 3. Output Characteristics @ T_J = 125°C

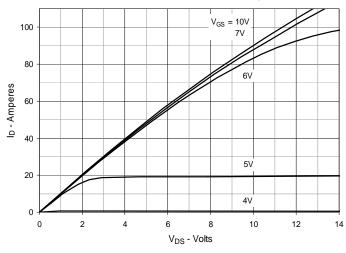


Fig. 4. $R_{DS(on)}$ Normalized to I_D = 55A Value vs. Junction Temperature

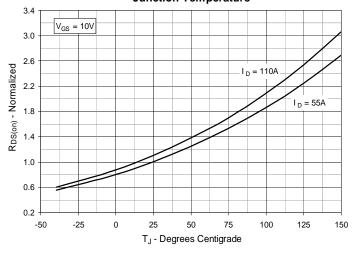


Fig. 5. $R_{DS(on)}$ Normalized to I_D = 55A Value vs.

Drain Current

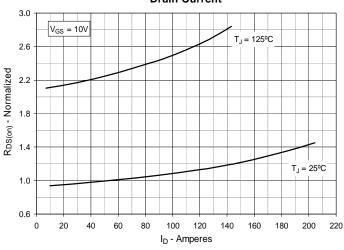
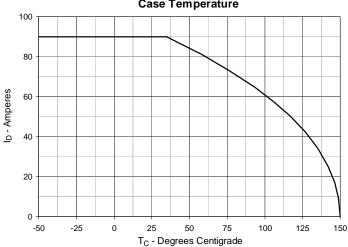


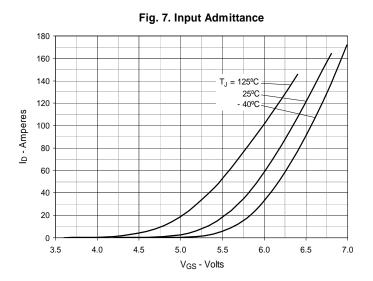
Fig. 6. Maximum Drain Current vs.

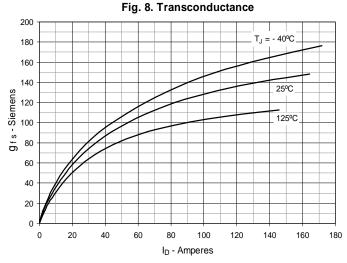
Case Temperature

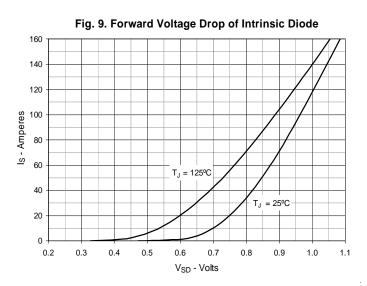


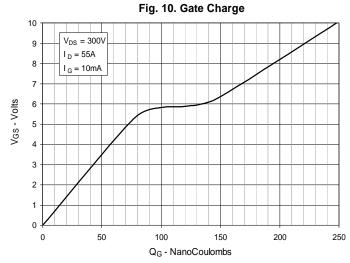
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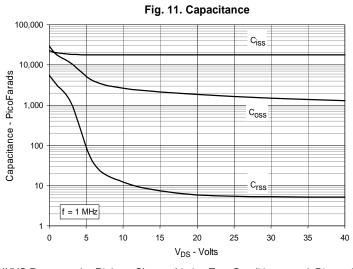


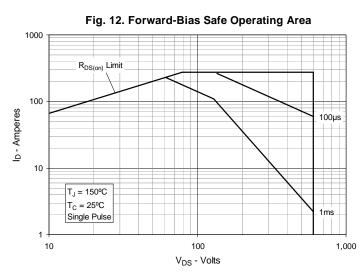












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